TOSHIBA TLP762JF

**TENTATIVE** 

TOSHIBA PHOTOCOUPLER GaAs IRED + PHOTO-TRIAC

## **TLP762JF**

OFFICE MACHINE

HOUSEHOLD USE EQUIPMENT

TRIAC DRIVER

**SOLID STATE RELAY** 

The TOSHIBA TLP762JF consists of a GaAs infrared LED optically coupled to a photo-triac in a 6 lead plastic DIP.

Peak Off-State Voltage : 600V (MIN.) Trigger LED Current : 10mA (MAX.) On-State Current : 100mA (MAX.)

UL Recognized : UL1577, File No. E67349

BSI Approved : BS EN60065: 1994,

> Certificate No. 7831 BS EN60950: 1992, Certificate No. 7832

SEMKO Approved : SS-EN60065 (EN60065, 1993)

> SS-EN60950 (EN60950, 1992) SS-EN60335 (EN60335, 1988) Certificate No. 9522145

Isolation Voltage : 4000Vrms (Min.)

Option (D4) type

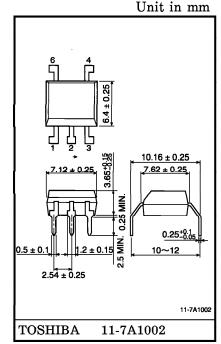
VDE Approved : DIN VDE0884/06.92, Certificate No. 91803

Maximum Operating Insulation Voltage: 1130Vpk Highest Permissible Over Voltage : 6000VpK

(Note) When a VDE0884 approved type is needed, please designate the "Option (D4)"

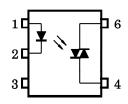
Creepage Distance : 8.0mm (Min.) Clearance : 8.0mm (Min.) Internal Creepage Path : 4.0mm (Min.)

Please refer to the technical data of TLP762J for MAXIMUM RATINGS and ELECTRICAL CHARACTERISTICS.



Weight: 0.42g

## PIN CONFIGURATION (TOP VIEW)



1: ANODE 2: CATHODE

3:NC4: TRIAC 1 6:TRIAC 2

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Insulation Thickness

: 0.4mm (Min.)